

A withstand voltage tester (page 10)



COMPUTEX TAIPEI 2012: INNOVATION FORUM

Innovations Drive Momentum, Future Growth for ICT, CE _____ **32**

Opening Speech
Panasonic Gives Preview of Future Smart TV _____ **33**

Keynote
New Qualcomm Snapdragon Innovates High-Performance Mobile Computing _____ **34**
ST Seizes Opportunities in Multimedia Convergence _____ **35**
NTT DOCOMO's LTE-Advanced Provides Migration Path to True 4G _____ **36**

NVIDIA Charts Game Plan for New Generation of Consumers _____ **37**

Special Address
Ericsson Helps Realize ICT Maturity Amid Urbanization Trends _____ **38**

Technology Session
NXP Ensures Safety in Converged Environment _____ **39**
Smart Access Makes Cloud Telematics Possible _____ **39**
Skyvia's Solutions Enable Converged Home Network _____ **40**
Anritsu's Test Solution Covers Entire LTE Device Test Cycle _____ **40**

Cambrios' ClearOhm Moves Transparent Conductors to New Heights _____ **41**
ST's Full Sensor Ecosystem Drives Emerging Applications _____ **41**

TranSwitch Offers Best Alternative to LVDS _____ **42**
Opportunities Abound for Gesture Recognition _____ **42**
Himax Addresses Challenges of Future Displays _____ **43**

Panel Discussion
Major CE, Mobile Players in Emerging Markets Eye Next Revenue Streams _____ **44**

Show Report
Age of Full-Fledged Global Diffusion of ICT Opens Up _____ **30**
Ultrabooks, Windows RT-Enabled Device Lift Toshiba's Computing Lineup _____ **46**
Rovi, MStar Cooperate on Streaming Video Technology _____ **46**
MediaTek's 802.11ac Solutions Suit High Quality Triple Play Applications _____ **47**
HDwire Alters LVDS Cables _____ **47**

SPECIAL REPORT

Safety Tests Standards & Trends
T&M Makers Rally Behind Product Safety _____ **10**
Kikusui Electronics Leaps Past Measuring Tools _____ **12**
HIOKI Builds Presence, Branding in Asia _____ **15**
Kikusui Electronics Designs Strategic Voltage Tester _____ **18**
HIOKI's Power Measuring Tools Meet PSE Compliance _____ **20**

TECHNOLOGY FOCUS

Noise Suppression Technologies Spread to Growth Fields _____ **22**
JNC Taps New Metal Sheet in Heat Dissipation Technology _____ **24**
High-Sensitivity Detection Defines SMK's Touch Technology _____ **27**

SMTs: IN REVIEW

_____ **48**

COMPONENT MATERIALS

_____ **53**

TEST AND MEASUREMENTS

_____ **56**

SHOW PREVIEW

electronica and productronica India 2012
PCB Event Embraces Players from Full Electronics Spectrum _____ **61**

DEPARTMENTS

	AEI News	8
	Techwatch	9
	Business Strategy	62
	Product News	64

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